



# Power MOSFETS

## DATASHEET

**LM30021NAK8A**

N-Channel  
Enhancement Mode MOSFET

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Quality Management Systems  
ISO 9001:2015 Certificate

## N-Channel Enhancement Mode MOSFET

### Pin Description

PDFN5*6-8L (TOP view)	Symbol	Symbol	N-Channel	Unit
		$V_{DSS}$	30	V
		$R_{DS(ON)-Max}$	2.2	$\text{m}\Omega$
		$ID$	125	A

### Feature

- Fast switching speed
- Surface mount package
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS & RG tested

### Product Summary

### Applications

- DC-DC Converters
- Motor Control
- Portable equipment application

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM30021NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	30021 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note:      = Lot code

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$	A
$I_{DM}^{\text{(1)}}$	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$	A
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$	A
		$T_C=100^\circ\text{C}$	79
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	W
		$T_C=100^\circ\text{C}$	20
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	22
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	1.6
$I_{AS}^{\text{(2)}}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	A
		$L=0.5\text{mH}$	A
$E_{AS}^{\text{(2)}}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	mJ
		$L=0.5\text{mH}$	210

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	$^\circ\text{C/W}$
$R_{\theta JA}^{\text{(3)}}$	Thermal Resistance-Junction to Ambient	Steady State	$^\circ\text{C/W}$

Note ① : Max. current is limited by junction temperature.

Note ② : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

Note ③ : UIS tested and pulse width are limited by maximum junction temperature 150°C.

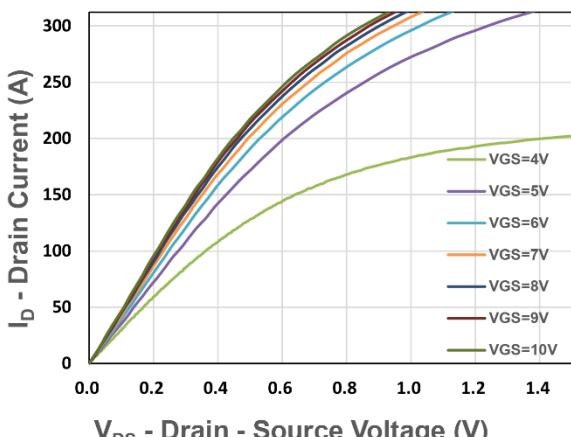
**N-Channel Electrical Characteristics** ( $T_J=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{DS}}=250\mu\text{A}$	30	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{DS}}=250\mu\text{A}$	1	1.5	2	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	$\text{nA}$
$R_{\text{DS(ON)}}^{\text{(4)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{DS}}=20\text{A}$	-	1.8	2.2	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{DS}}=15\text{A}$	-	2.5	3.3	
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}$ , $I_{\text{DS}}=10\text{A}$	-	33	-	S
<b>Dynamic Characteristics</b> <sup>(5)</sup>						
$R_{\text{G}}$	Gate Resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , Freq.=1MHz	-	2	-	$\Omega$
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=15\text{V}$ , Freq.=1MHz	-	3490	-	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		-	444	-	
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	390	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=1\text{A}$ , $R_{\text{GEN}}=6\text{R}$	-	12.5	-	$\text{nS}$
$t_{\text{r}}$	Turn-on Rise Time		-	21	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	127	-	
$t_{\text{f}}$	Turn-off Fall Time		-	60	-	
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}$ , $V_{\text{DS}}=15\text{V}$ $I_{\text{D}}=20\text{A}$	-	41	-	$\text{nC}$
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=15\text{V}$ , $I_{\text{D}}=20\text{A}$	-	85	-	
$Q_{\text{gs}}$	Gate-Source Charge		-	17.2	-	
$Q_{\text{gd}}$	Gate-Drain Charge		-	16	-	
<b>Source-Drain Characteristics</b>						
$V_{\text{SD}}^{\text{(4)}}$	Diode Forward Voltage	$I_{\text{SD}}=15\text{A}$ , $V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{F}}=15\text{A}$ , $V_{\text{GS}}=0\text{V}$	-	30.6	-	$\text{nS}$
$Q_{\text{rr}}$	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	23.7	-	$\text{nC}$

Note <sup>(4)</sup> : Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

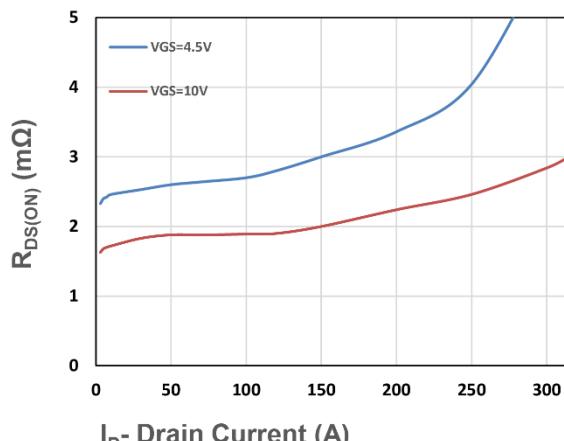
Note <sup>(5)</sup> : Guaranteed by design, not subject to production testing.

## N-Channel Typical Characteristics



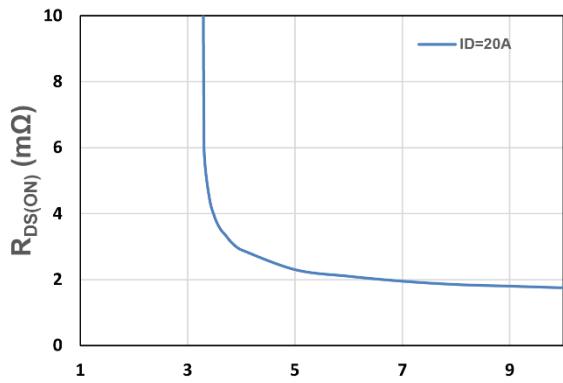
$V_{DS}$  - Drain - Source Voltage (V)

Figure 1. Output Characteristics



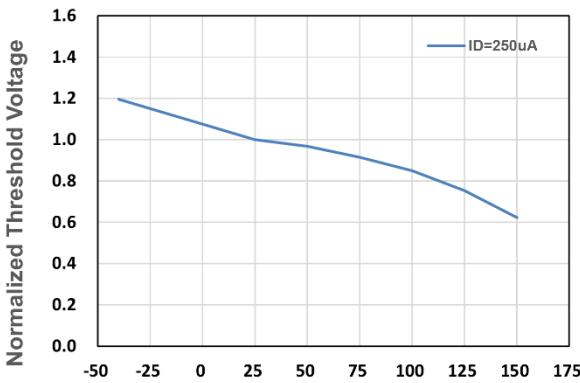
$I_D$ - Drain Current (A)

Figure 2. On-Resistance vs. ID



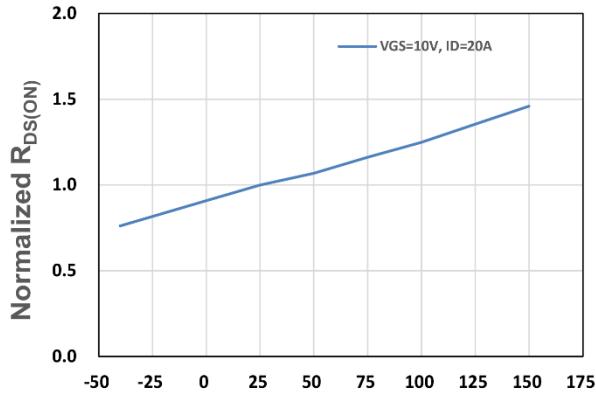
$V_{GS}$  - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



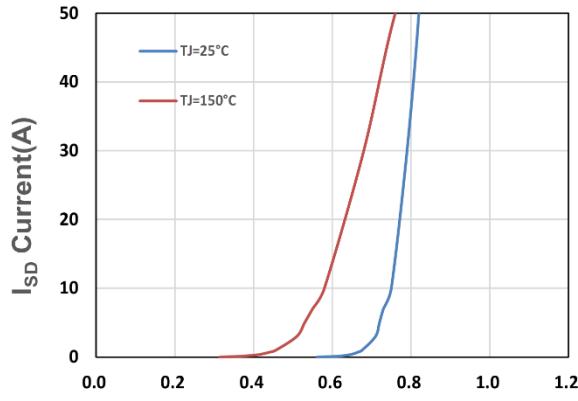
$T_j$ , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



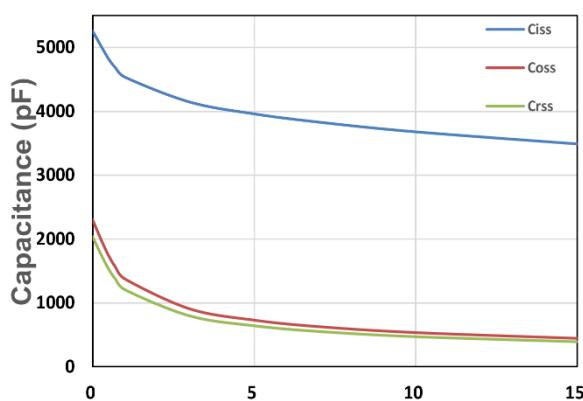
$T_j$  , Junction Temperature(°C)

Figure 5. Drain-Source On Resistance

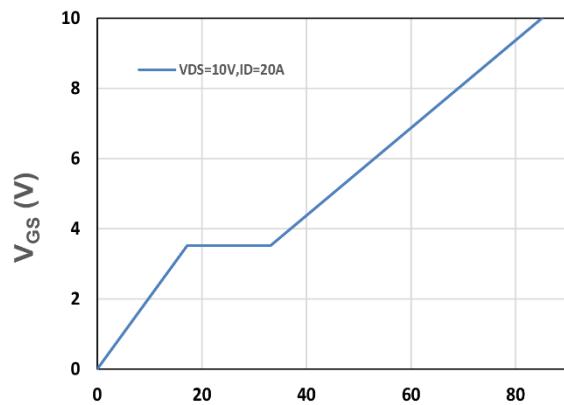


$V_{SD}$ , Source-Drain Voltage(V)

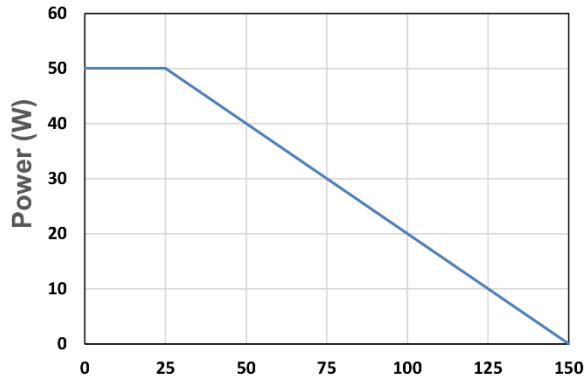
Figure 6. Source-Drain Diode Forward



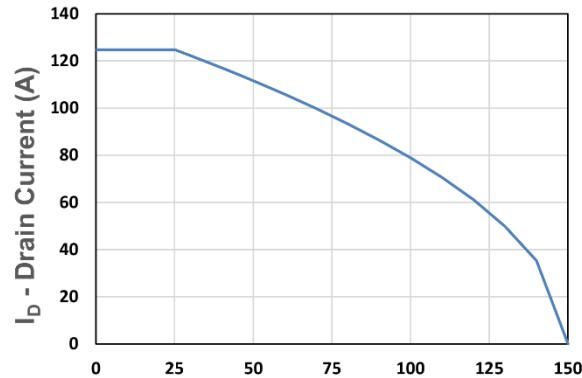
$V_{DS}$  - Drain - Source Voltage (V)  
Figure 7. Capacitance



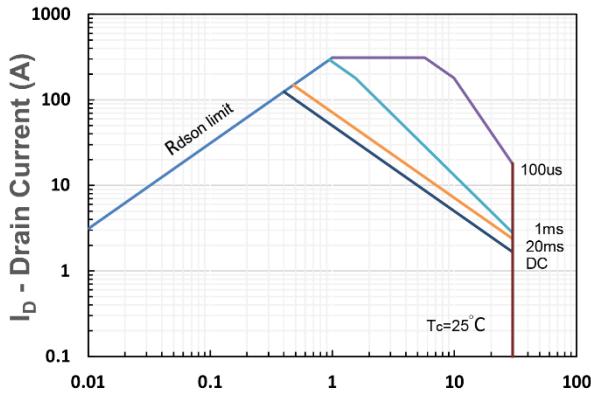
$Q_g$ , Total Gate Charge (nC)  
Figure 8. Gate Charge Characteristics



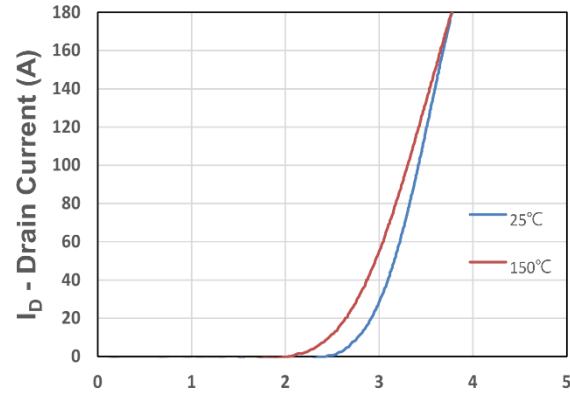
$T_c$  - Case Temperature (°C)  
Figure 9. Power Dissipation



$I_D$  - Drain Current (A)  
Figure 10. Drain Current



$V_{DS}$  - Drain-Source Voltage (V)  
Figure 11. Safe Operating Area



$V_{GS}$  - Gate - Source Voltage (V)  
Figure 12. Transfer Characteristics

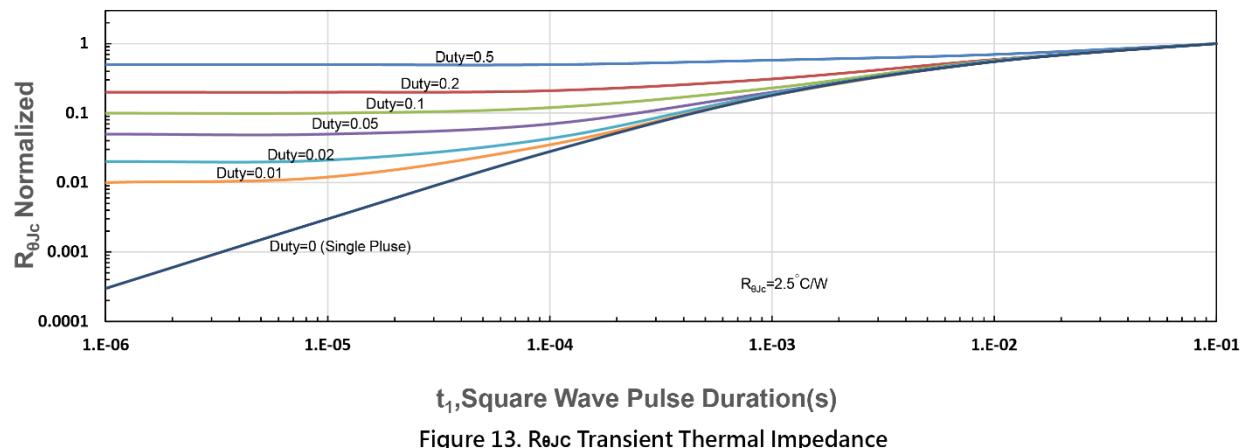


Figure 13.  $R_{\theta JC}$  Transient Thermal Impedance